



NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE0130 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

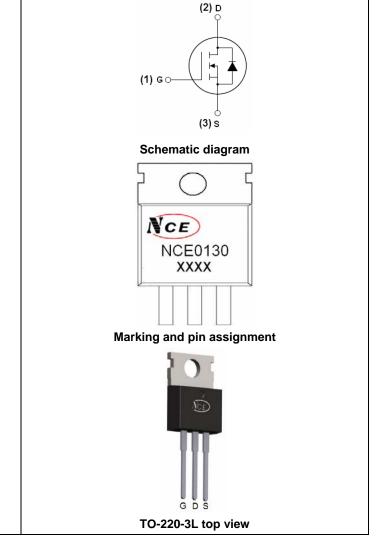
- $V_{DS} = 100V, I_D = 30A$ $R_{DS(ON)} < 28m\Omega @ V_{GS} = 10V$ (Typ:24 m Ω)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0130	NCE0130	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25[°]Cunless otherwise noted)

Symbol	Parameter	Limit	Unit	
Vds	Drain-Source Voltage	100	V	
Vgs	Gate-Source Voltage	±20	V	
Ι _D	Drain Current-Continuous	30	А	
I _D (100℃)	Drain Current-Continuous(TC=100℃)	21	А	
I _{DM}	Pulsed Drain Current	70	A	
PD	Maximum Power Dissipation	75	W	
	Derating factor	0.5	W/°C	
E _{AS}	Single pulse avalanche energy (Note 5)	256	mJ	
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 175	°C	



Pb Free Product



Thermal Characteristic

R _{θJC} Thermal Resistance, Junction-to-Case (Note 2)2.0°C

Electrical Characteristics (T_c=25[°]Cunless otherwise noted)

Sym	bol	Parameter	Condition	Min	Тур	Max	Unit
Off Characteristics							
BV _{DSS}	Drain-Source Breakdown Voltage		V _{GS} =0V I _D =250µA	100	110	-	V
I _{DSS}	Zero Gate Voltage Drain Current		V _{DS} =100V,V _{GS} =0V	-	-	1	μA
I _{GSS}	Gate-Body Leakage Current		V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (N	ote 3)		·	•	•		
V _{GS(th)}	Gate Threshold Voltage		V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V
R _{DS(ON)}	Drain-Source On-Sta	ate Resistance	V _{GS} =10V, I _D =15A	-	24	28	mΩ
g _{FS}	Forward Transconductance		V _{DS} =5V,I _D =10A -		15	-	S
Dynamic Characteris	tics ^(Note4)						
C _{lss}	Input Capac	tiance		-	2000	-	PF
Coss	Output Capa	citance	V_{DS} =25V, V_{GS} =0V,	-	300	-	PF
C _{rss}	Reverse Transfer Capacitance		F=1.0MHz	-	250	-	PF
Switching Character	stics (Note 4)						
t _{d(on)}	Turn-on Dela	ay Time		-	7	-	nS
tr	Turn-on Rise	e Time	V_{DD} =50V,RL=5 Ω	-	7	-	nS
t _{d(off)}	Turn-Off Dela	ay Time	V_{GS} =10V, R_{GEN} =3 Ω	-	29	-	nS
t _f	Turn-Off Fa	ll Time		-	7	-	nS
Qg	Total Gate 0	Charge		-	39	-	nC
Q _{gs}	Gate-Source	Charge	$V_{DS}=50V, I_{D}=18A,$	-	8	-	nC
Q _{gd}	Gate-Drain (Charge	V _{GS} =10V	-	12	-	nC
Drain-Source Diode	Characteristics		·	•	•		
V _{SD}	Diode Forward V	oltage (Note 3)	V _{GS} =0V,I _S =20A	-	-	1.2	V
ls	Diode Forward C		-	-	-	30	А
t _{rr}	Reverse Recov	ery Time	TJ = 25°C, IF = 18A	-	32	-	nS
Qrr	Reverse Recove	ery Charge	di/dt = 100A/µs ^(Note3)	-	53	-	nC
t _{on}	Forward Turn-	On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				v LS+LD)

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle ≤ 2%.

4. Guaranteed by design, not subject to production

5. EAS Condition : Tj=25 $^\circ \! \mathrm{C}$,V_{DD}=50V,V_G=10V,L=0.5mH,Rg=25\Omega, I_{AS}=32A

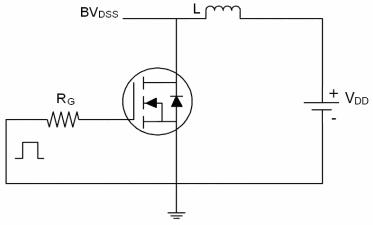


http://www.ncepower.com

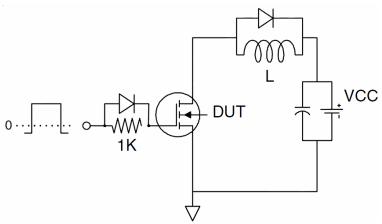
Pb Free Product



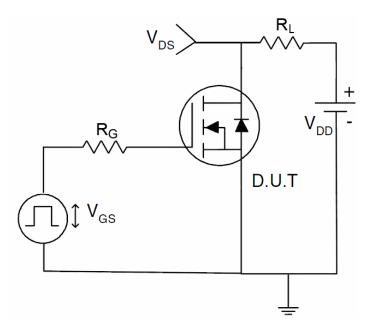
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



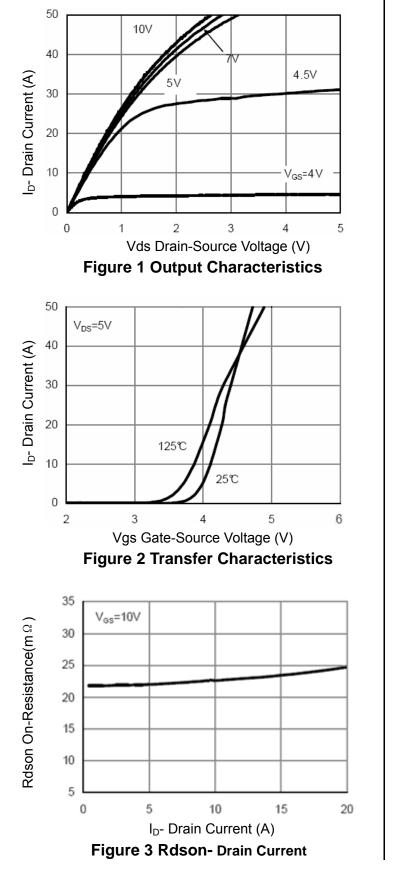
3) Switch Time Test Circuit

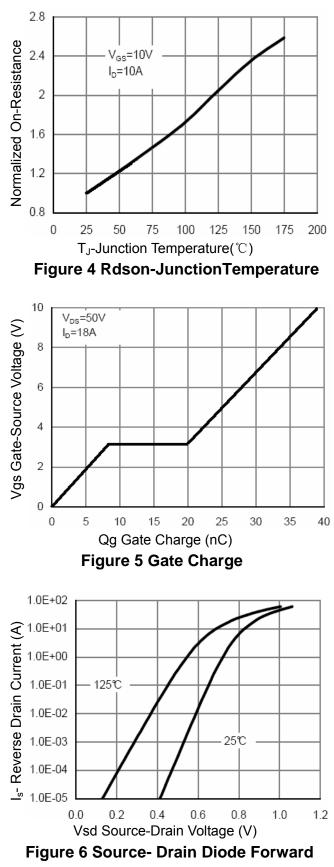






Typical Electrical and Thermal Characteristics (Curves)







http://www.ncepower.com

NCE0130

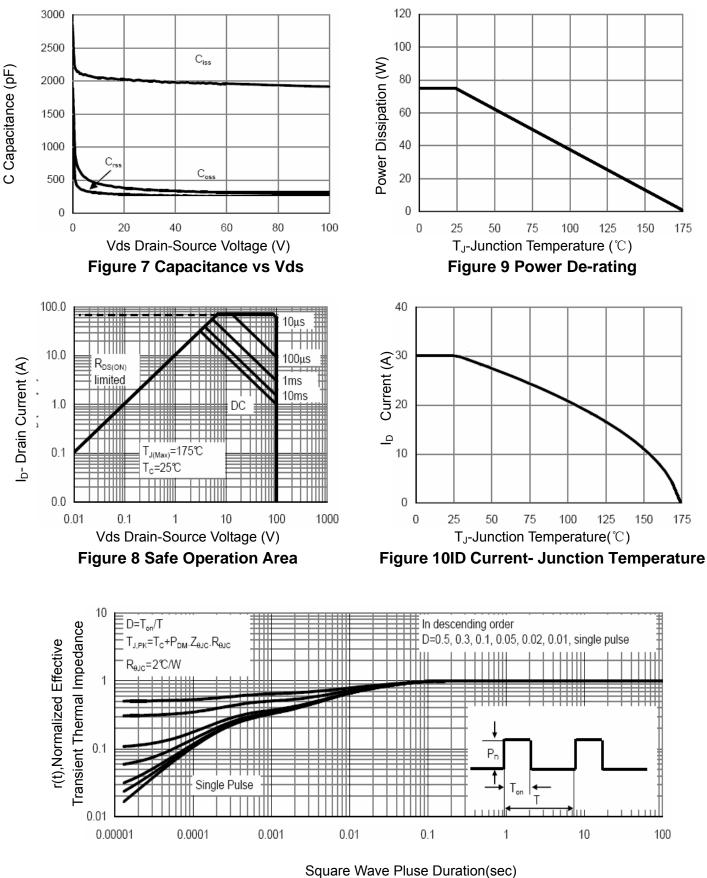


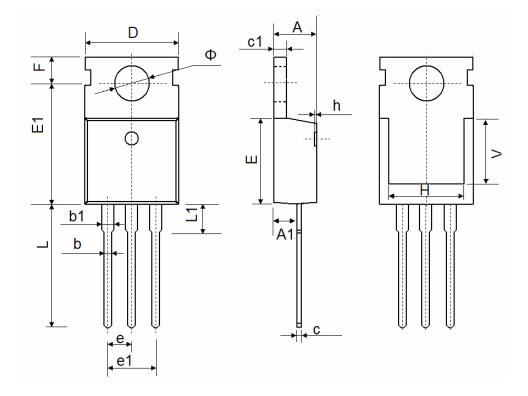
Figure 11 Normalized Maximum Transient Thermal Impedance



http://www.ncepower.com



TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500) REF.	0.295 REF.		
Ф	3.400	3.800	0.134	0.150	







Attention:

- Any and all NCE power products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your NCE power representative nearest you before using any NCE power products described or contained herein in such applications.
- NCE power assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all NCE power products described or contained herein.
- Specifications of any and all NCE power products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- NCE power Semiconductor CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all NCE power products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of NCE power Semiconductor CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. NCE power believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the NCE power product that you intend to use.
- This catalog provides information as of Sep.2010. Specifications and information herein are subject to change without notice.